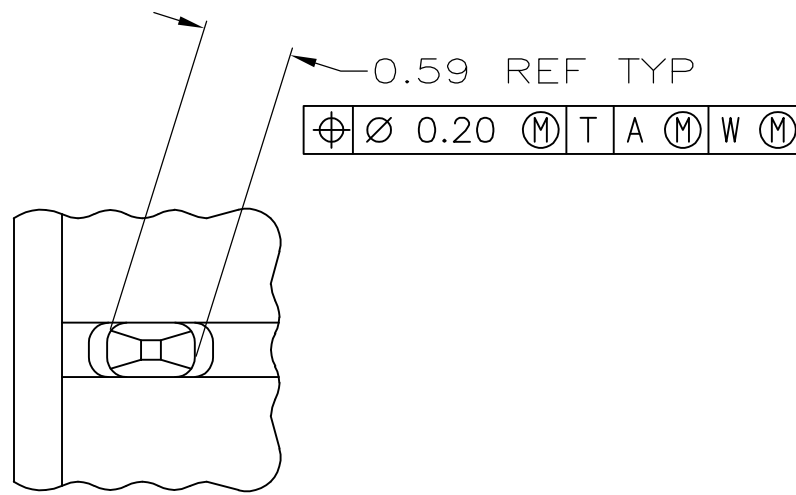
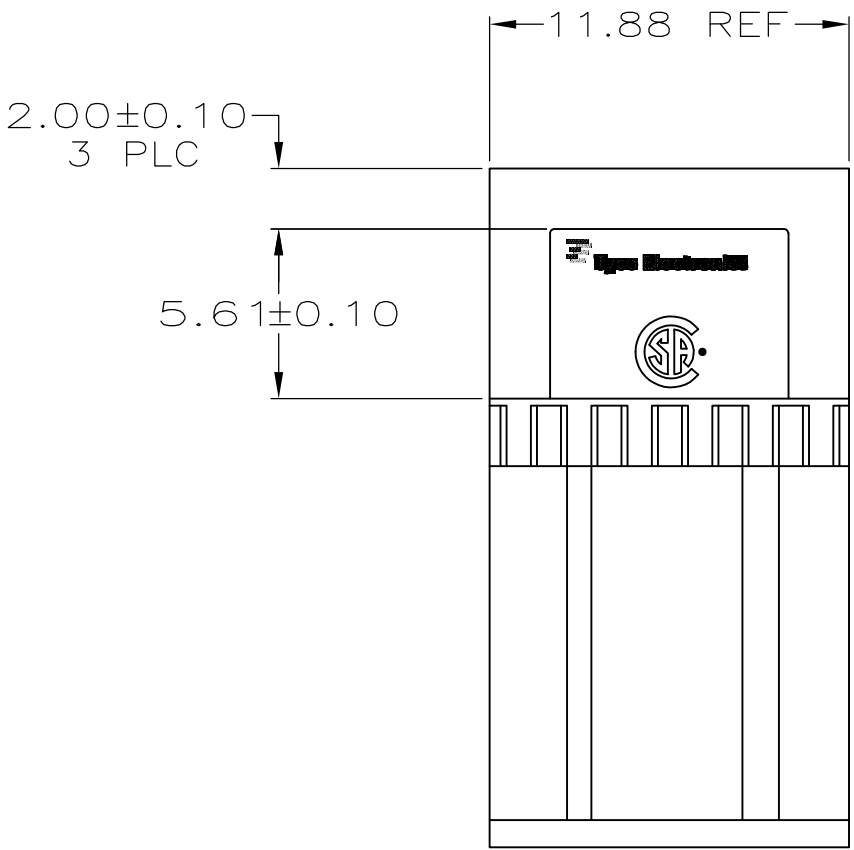


D

C

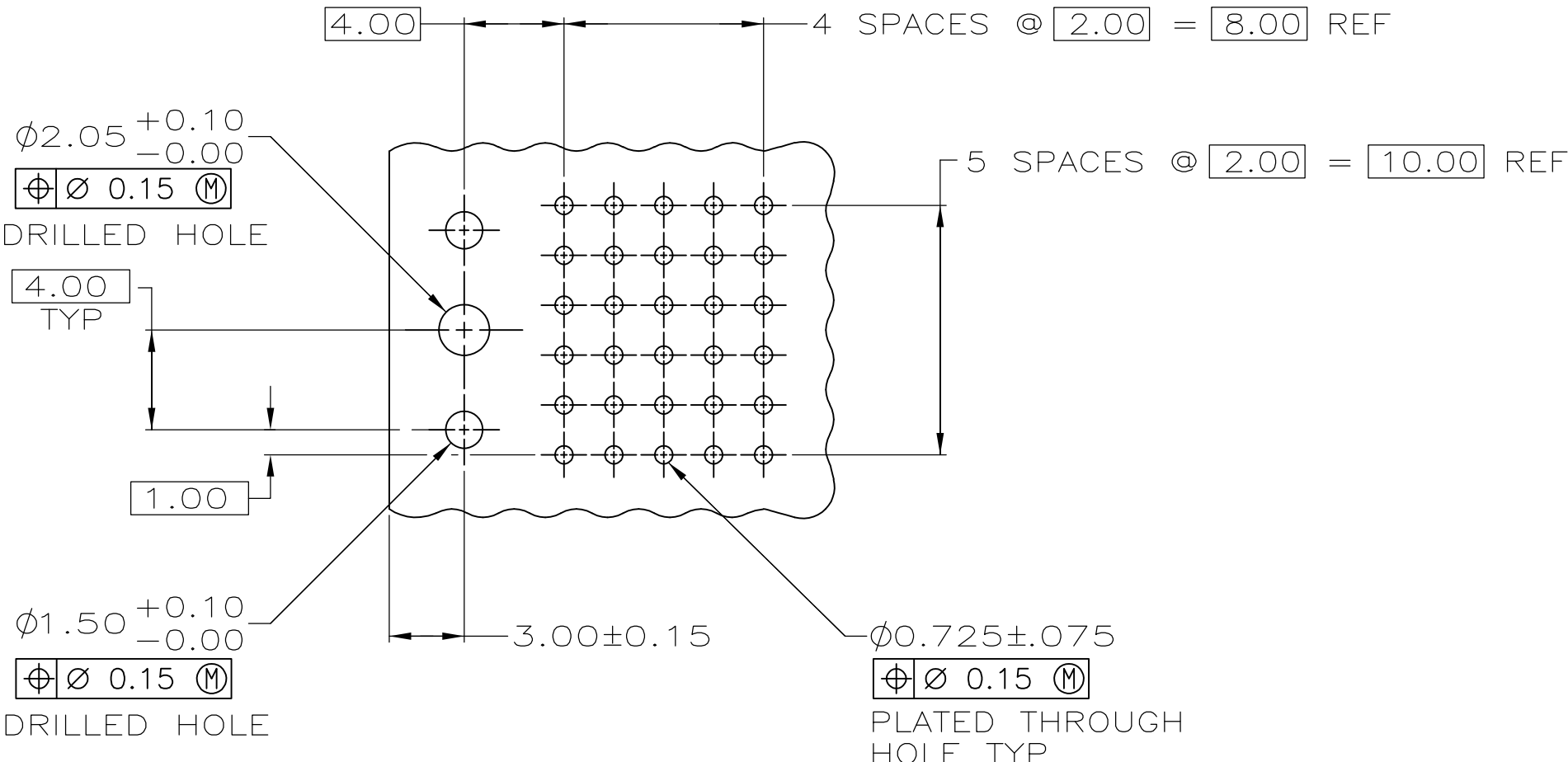
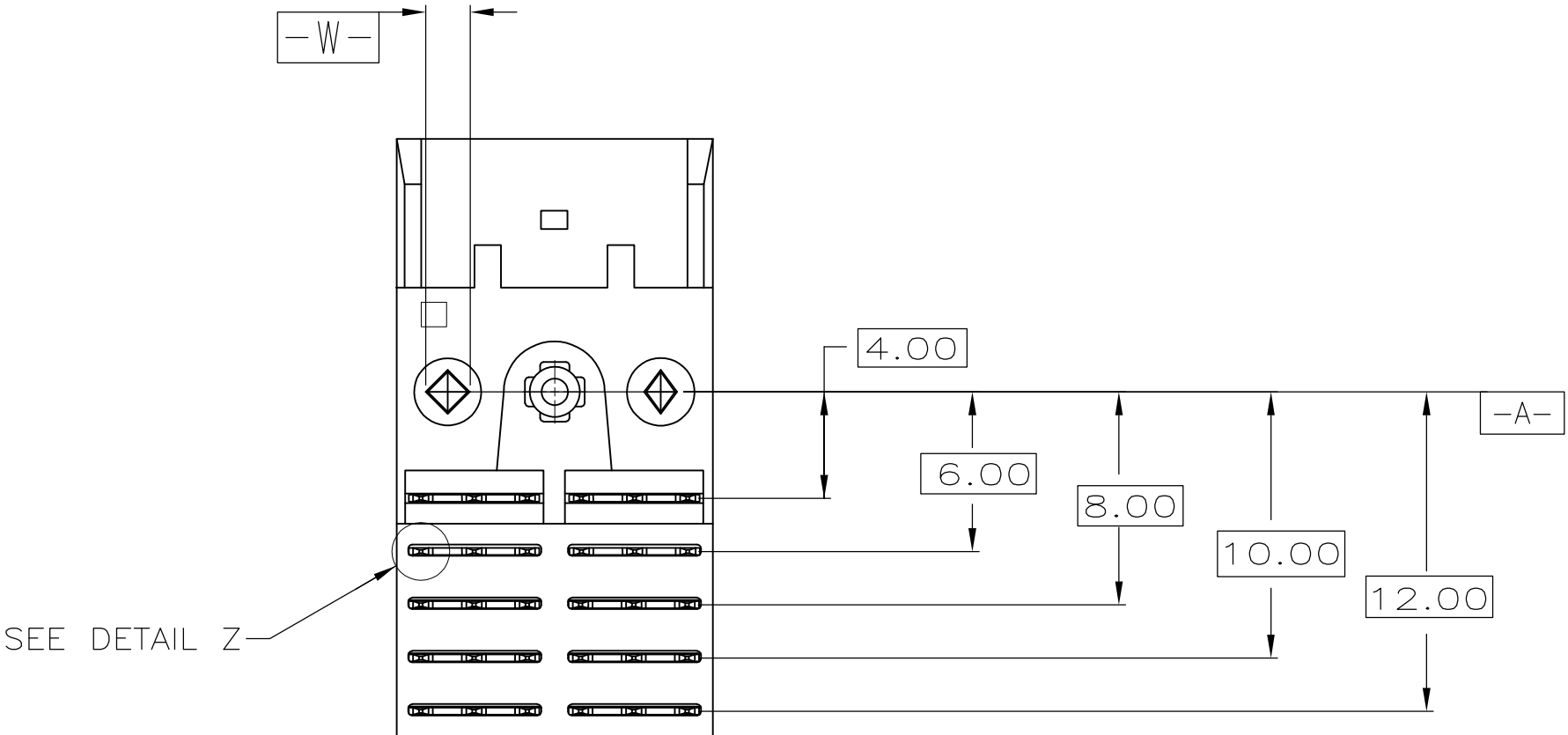
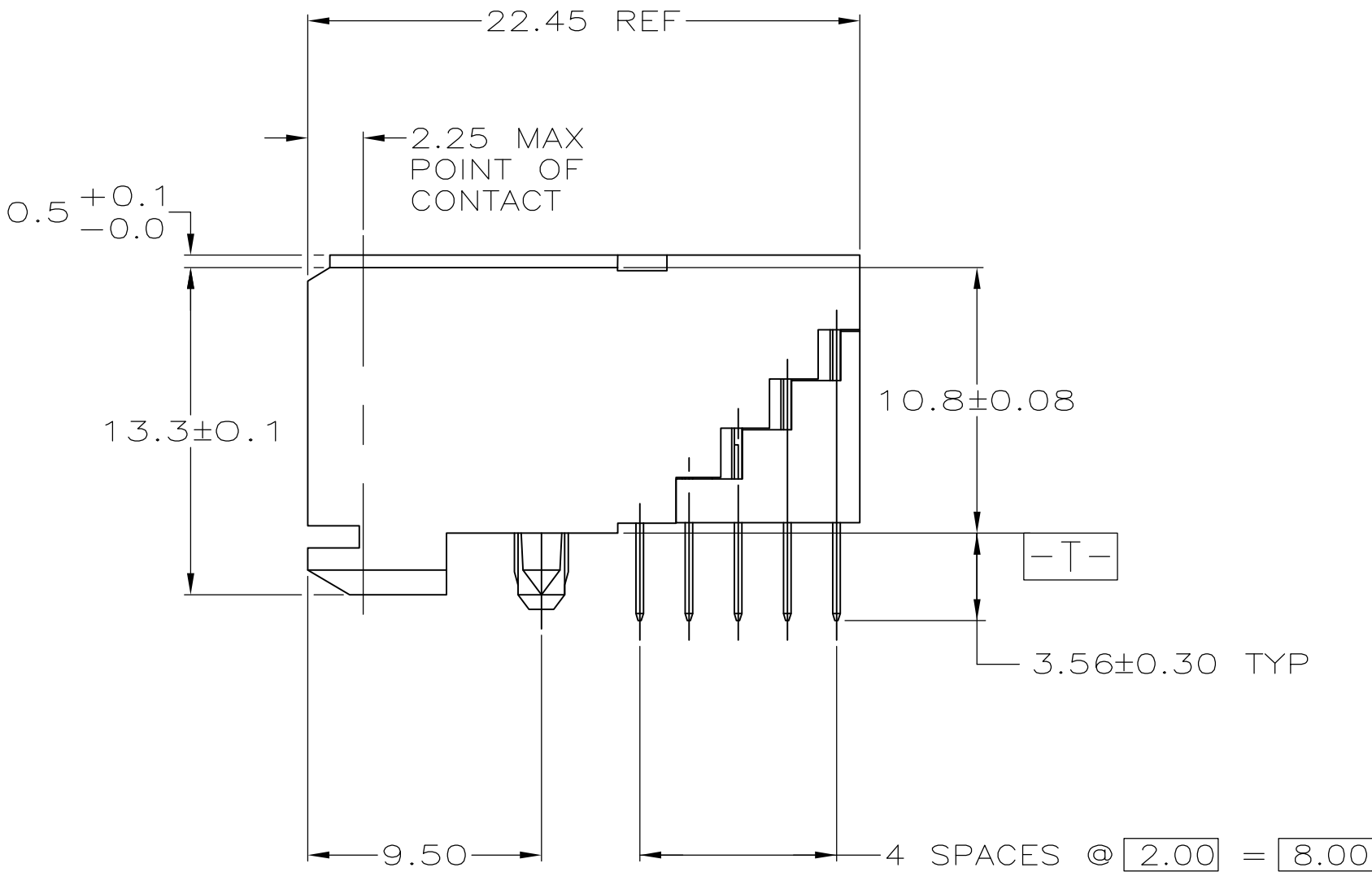
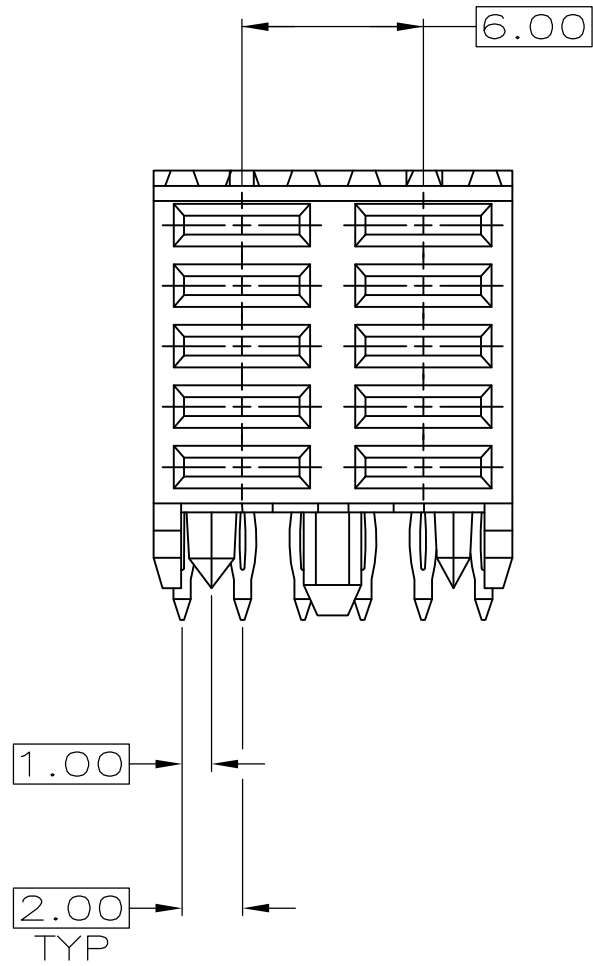
B

A



DETAIL Z
SCALE 20:1

- 1 HOUSINGS MATERIAL: LIQUID CRYSTAL POLYMER.
- 2 CONTACT MATERIAL: COPPER ALLOY
- 3 CONTACT FINISH:
UNDERPLATE (ENTIRE CONTACT):
0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290
ON MATING SURFACES:
FLASH GOLD PER ASTM B 488, OVER
0.00076 MIN PALLADIUM-NICKEL OVER UNDERPLATE, OR
0.00076 MIN GOLD PER ASTM B 488 OVER UNDERPLATE.
ON LEADS:
0.00127 MIN TIN-LEAD OVER UNDERPLATE.
LUBRICATION (MIN MATING SURFACES):
SURFACE CONDITIONER AFTER PLATING.



RECOMMENDED CURCUIT PATTERN
PER IPC-D300 TYPE II, CLASS C
(COMPONENT SIDE)

3	536676-1
FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN T. SHUEY 5-29-98	Tyco Electronics Corporation Harrisburg, PA 17105-3608	
DIMENSIONS: mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	CHK D. KOVALICK 6-2-99	NAME D. KOVALICK 6-2-98	PRODUCT SPEC ROPT ASSEMBLY POWER Z-PACK 2mm FB, R/A,5 ROW,10 POSN,W/TAIL ORGANIZER
		APVD D. KOVALICK		
	0 PLC ± - 1 PLC ± - 2 PLC ± 0.13 3 PLC ± - 4 PLC ± - ANGLES ± -	APPLICATION SPEC	SIZE CODE CODE DRAWING NO	RESTRICTED TO
		WEIGHT		
MATERIAL	FINISH	CUSTOMER DRAWING	SCALE 4:1	SHEET 1 of 1 REV J1

Mouser Electronics

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